



ADN553

Embedded 3.5" SBC

User's Manual

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FCC and DOC Statement on Class A

This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to Part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and the receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio TV technician for help.

Notice:

1. The changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.
2. Shielded interface cables must be used in order to comply with the emission limits.

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About this Manual

This manual can be retrieved from the website.

The manual is subject to change and update without notice, and may be based on editions that do not resemble your actual products. Please visit our website or contact our sales representatives for the latest editions.

Warranty

1. Warranty does not cover damages or failures that arises from misuse of the product, inability to use the product, unauthorized replacement or alteration of components and product specifications.
2. The warranty is void if the product has been subjected to physical abuse, improper installation, modification, accidents or unauthorized repair of the product.
3. Unless otherwise instructed in this user's manual, the user may not, under any circumstances, attempt to perform service, adjustments or repairs on the product, whether in or out of warranty. It must be returned to the purchase point, factory or authorized service agency for all such work.
4. We will not be liable for any indirect, special, incidental or consequential damages to the product that has been modified or altered.

About this Package

The package contains the following items. If any of these items are missing or damaged, please contact your dealer or sales representative for assistance.

- 1 ADN553 Board
- 1 Heat Sink (Height: 29 mm)

Note: The items are subject to change in the developing stage. The product and accessories in the package may not come similar to the information listed above. This may differ in accordance with the sales region or models in which it was sold. For more information about the standard package in your region, please contact your dealer or sales representative.

Static Electricity Precautions

It is quite easy to inadvertently damage your PC, system board, components or devices even before installing them in your system unit. Static electrical discharge can damage computer components without causing any signs of physical damage. You must take extra care in handling them to ensure against electrostatic build-up.

1. To prevent electrostatic build-up, leave the system board in its anti-static bag until you are ready to install it.
2. Wear an antistatic wrist strap.
3. Do all preparation work on a static-free surface.
4. Hold the device only by its edges. Be careful not to touch any of the components, contacts or connections.
5. Avoid touching the pins or contacts on all modules and connectors. Hold modules or connectors by their ends.



Important:

Electrostatic discharge (ESD) can damage your processor, disk drive and other components. Perform the upgrade instruction procedures described at an ESD workstation only. If such a station is not available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the system chassis. If a wrist strap is unavailable, establish and maintain contact with the system chassis throughout any procedures requiring ESD protection.

Safety Precautions

- Use the correct DC / AC input voltage range.
- Unplug the power cord before removing the system chassis cover for installation or servicing. After installation or servicing, cover the system chassis before plugging in the power cord.
- There is danger of explosion if battery incorrectly replaced.
- Replace only with the same or equivalent specifications of batteries recommend by the manufacturer.
- Dispose of used batteries according to local ordinance.
- Keep this system away from humid environments.
- Make sure the system is placed or mounted correctly and stably to prevent the chance of dropping or falling may cause damage.
- The openings on the system shall not be blocked and shall be kept in distance from

other objects to make sure of proper air ventilation to protect the system from over-heating.

- Dress the cables, especially the power cord, so they will not be stepped on, in contact with high temperature surfaces, or cause any tripping hazards.
- Do not place anything on top of the power cord. Use a power cord that has been approved for use with the system and is compliant with the voltage and current ranges required by the system's electrical specifications.
- If the system is to be unused or stored for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
- If one of the following occurs, consult a service personnel:
 - The power cord or plug is damaged.
 - Liquid has penetrated the system.
 - The system has been exposed to moisture.
 - The system is not working properly.
 - The system is physically damaged.
- The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace the outlet.
- Disconnect the system from the electricity outlet before cleaning. Use a damp cloth for cleaning the surface. Do not use liquid or spray detergents for cleaning.
- Before connecting, make sure that the power supply voltage is correct. The device is connected to a power outlet which should be grounded connection.



The system may burn fingers while running.

Wait for 30 minutes to handle electronic parts after power off.

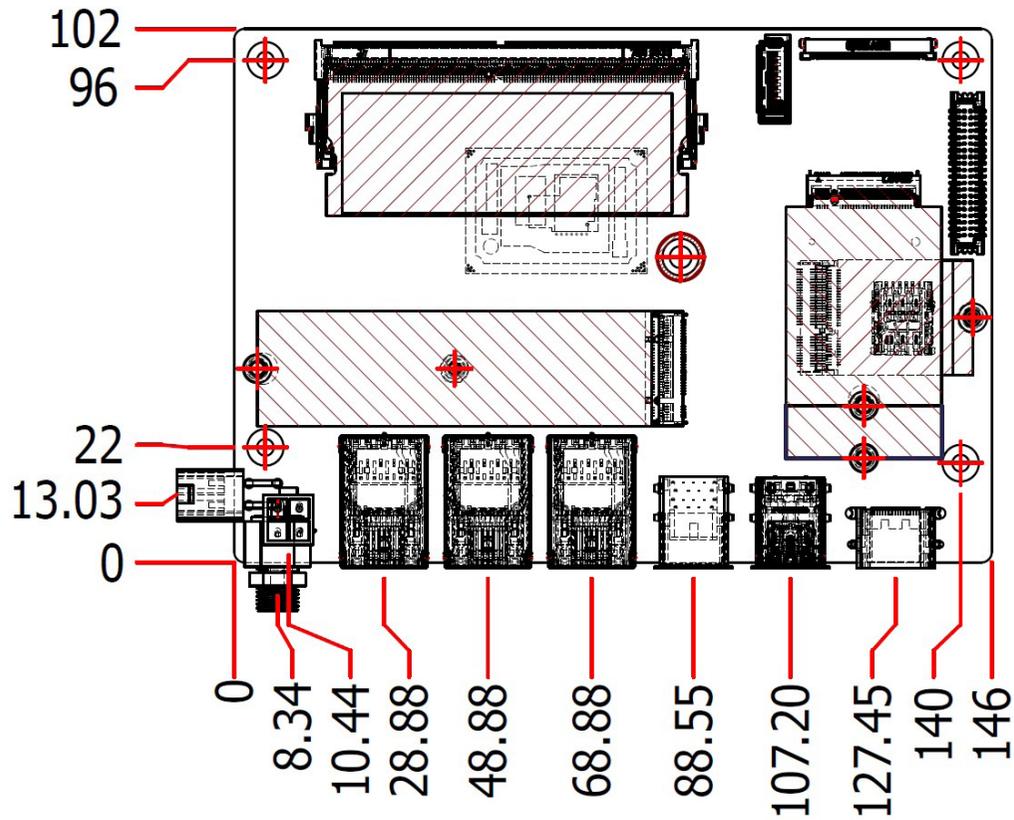
Chapter 1 - Introduction

► Specifications

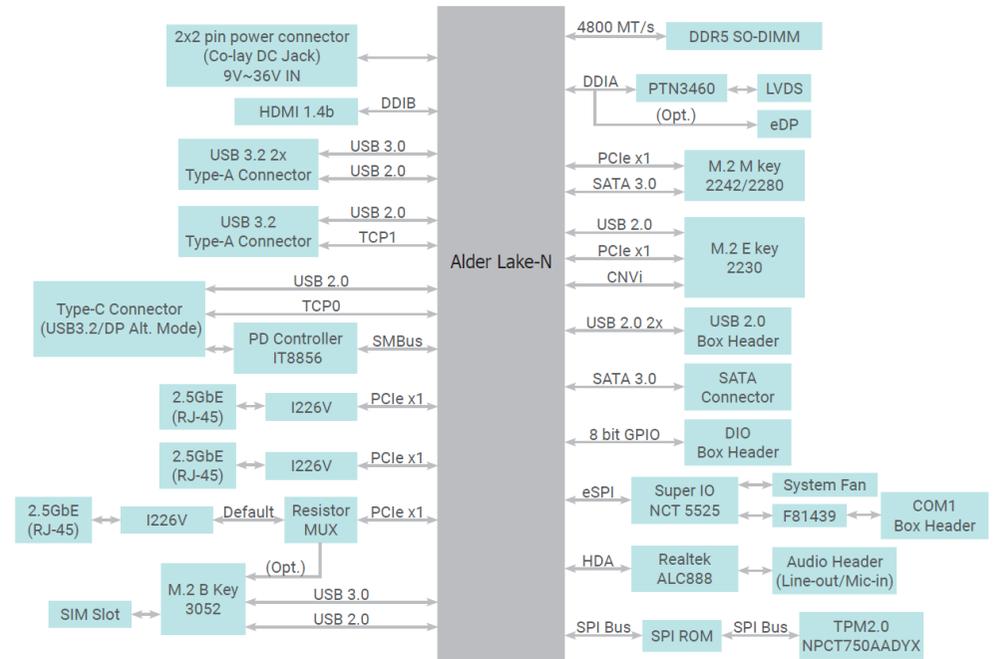
SYSTEM	Processor	Intel® Atom® Alder Lake-N Processors, TDP up to 15W Embedded Intel Atom® x7425E, 4 cores, 6M Cache, up to 3.40 GHz, 12W Intel Atom® x7213E, 2 cores, 6M Cache, up to 3.20 GHz, 10W Intel Atom® x7211E, 2 cores, 6M Cache, up to 3.20 GHz, 6W	
		PC Client Intel® Core™ i3-N305, 8 cores, 6M Cache, up to 3.80 GHz, 15W Intel® Processor N200, 4 cores, 6M Cache, up to 3.70 GHz, 6W Intel® Processor N97, 4 cores, 6M Cache, up to 3.60 GHz, 12W Intel® Processor N50, 2 cores, 6M Cache, up to 3.40 GHz, 6W	
		Memory	One 262-pin SODIMM up to 16GB Single Channel DDR5 4800MHz
		BIOS	AMI SPI 256Mbit
GRAPHICS	Controller	Intel® UHD Graphics	
	Feature	OpenGL 4.6, Direct X 12.1, OpenCL 3.0 HW Decode: HEVC, VP9, AV1, AVC HW Encode: HEVC, VP9, AVC	
	Display	1 x HDMI HDMI: resolution up to 4096x2160@24Hz 1 x Type-C DP Alt. Mode DP: resolution up to 3840x2160 @60Hz 1 x LVDS/eDP LVDS: dual channel 24-bit, resolution up to 1920x1200@60Hz eDP: resolution up to 4096x2160 @60Hz	
	Triple Display	HDMI + Type-C DP Alt. Mode + LVDS/eDP	
EXPANSION	Interface	1 x M.2 M key 2280/2242 (PCIe Gen3 x1/SATA3.0) 1 x M.2 B key 3052/3042 (USB3.0/USB2.0, optional PCIe x1) 1 x M.2 E key 2230 (USB/PCIe x1, support CNVi) 1 x SIM slot for 4G/5G	
AUDIO	Audio Codec	Realtek ALC888S	
ETHERNET	Controller	3 x Intel® I226V (10/100/1000/2500Mbps). LAN3 option with M.2 3052 PCIe x1.	
REAR I/O	Ethernet	3 x 2.5GbE (RJ-45)	
	USB	4 x USB 3.2	
	Display	1 x HDMI 1 x Type-C DP Alt. Mode	

INTERNAL I/O	Serial	1 x RS-232/422/485 (2.0mm pitch)
	USB	2 x USB 2.0 (2.0mm pitch)
	Display	1 x LVDS LCD Panel Connector and 1 x LCD/Inverter Power or 1 x eDP Connector
	Audio	1 x Audio (Line-out/Mic-in)
	SATA	1 x SATA 3.0 (up to 6Gb/s) 1 x SATA Power
	DIO	1 x 8-bit DIO
WATCHDOG TIMER	Output & Interval	System Reset, Programmable via Software from 1 to 255 Seconds
SECURITY	TPM	dTPM 2.0
	Type	Wide Range 9~36V DC
POWER	Connector	Right Angle Connector (4-pin) DC-in Jack (available upon request) Vertical Type Connector (4-pin) (available upon request)
	Consumption	Typical: i3-N305, 19V @ 0.45A (8.55W) Max: i3-N305, 19V @ 2.7A (51.3W)
	RTC Battery	CR2032 Coin Cell
OS SUPPORT	OS Support (UEFI Only)	Windows 10 IoT Enterprise (64-bit) Windows 11 Linux
MECHANISM	Dimensions	3.5" SBC Form Factor
	Height	PCB: 1.6mm Top Side: 15mm Bottom Side: 4mm
ENVIRONMENT	Temperature	Operating: -5 to 65°C
	Humidity	Operating: 5 to 90% RH
	MTBF	593,096 hrs @ 25°C; 398,330 hrs @ 45°C; 276,293 hrs @ 60°C Calculation Model: Telcordia Issue 4 Environment: GB, GC - Ground Benign, Controlled
STANDARDS AND CERTIFICATIONS	Certifications	CE, FCC Class B, RoHS

► Dimensions



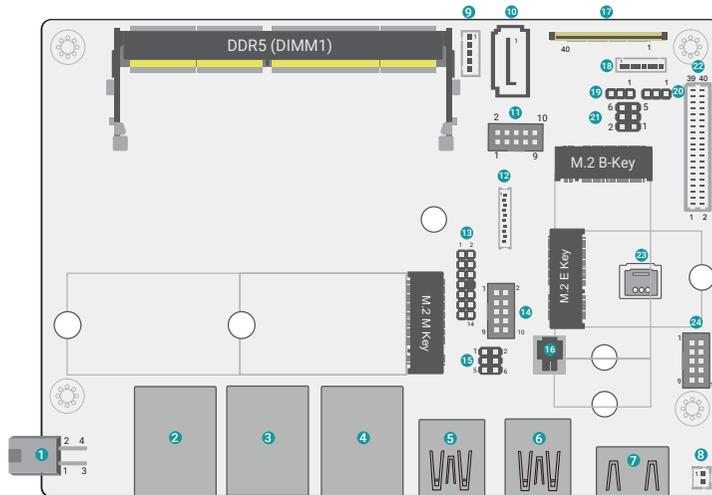
► Block Diagram



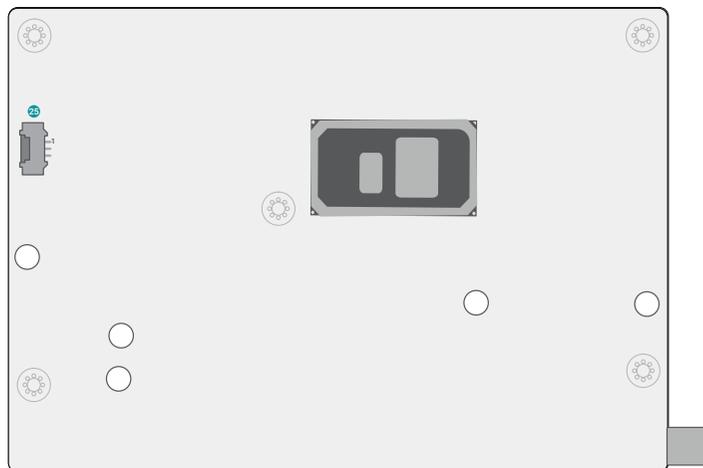
Chapter 2 - Hardware Installations

► Overview

Top View



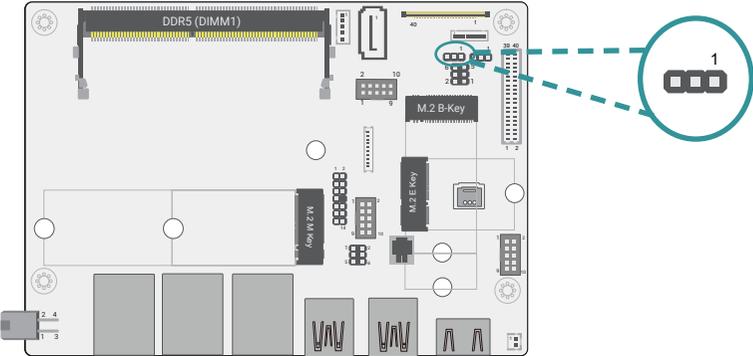
Bottom View



- | | | | |
|----|-----------------------------|----|--|
| 1 | Power Connector | 14 | COM1 |
| 2 | 2.5G LAN1 | 15 | Front Panel |
| 3 | 2.5G LAN2 | 16 | SPI ROM |
| 4 | 2.5G LAN3 | 17 | eDP |
| 5 | USB3.2 Gen2 | 18 | LVDS Inverter Power |
| 6 | ▲USB3.2 Gen1
▼USB Type-C | 19 | Panel Backlight Selection |
| 7 | HDMI | 20 | Panel Inverter/Backlight Power Selection |
| 8 | RTC Battery | 21 | Panel VDD Power Jumper |
| 9 | SATA Power | 22 | LVDS |
| 10 | SATA 3.0 | 23 | SIM Card Slot |
| 11 | USB2.0 6/7 | 24 | Front Audio |
| 12 | DIO | 25 | System Fan |
| 13 | eSPI & UART Debug | | |

► **Jumper Settings**

Panel Backlight Selection (DPJP1)

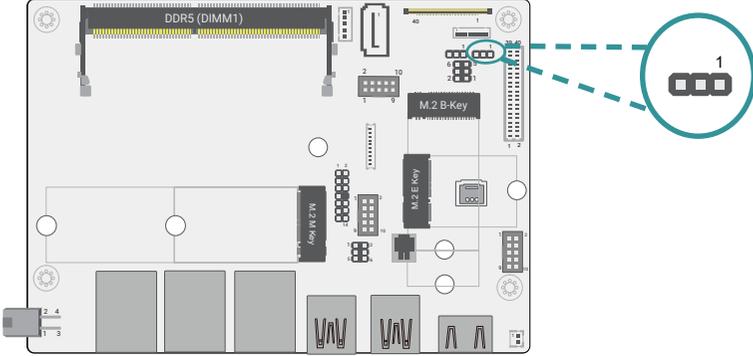


■ 1-2 On: 3.3V (default)



■ 2-3 On: 5V

Panel Inverter/Backlight Power Selection (DPJP2)

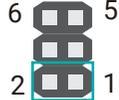
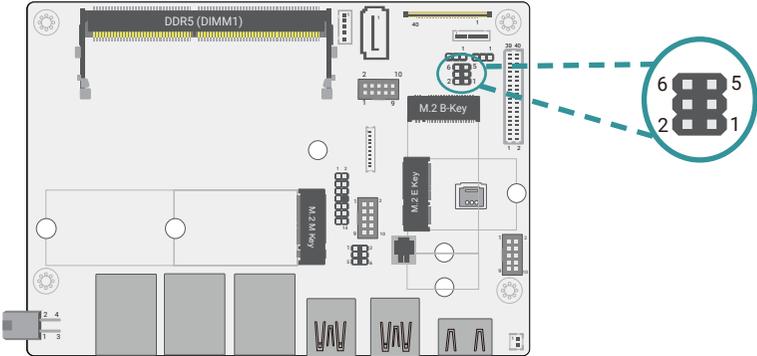


■ 1-2 On: 12V (default)

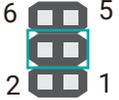


■ 2-3 On: 5V

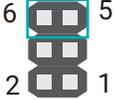
Panel VDD Power Jumper (DPJP3)



■ 1-2 On: 12V



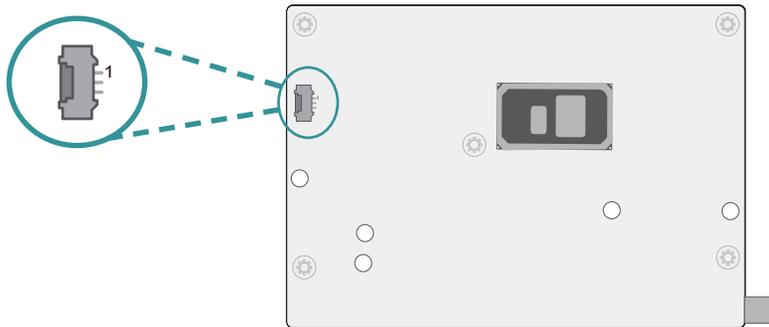
■ 3-4 On: 5V



■ 5-6 On: 3.3V (default)

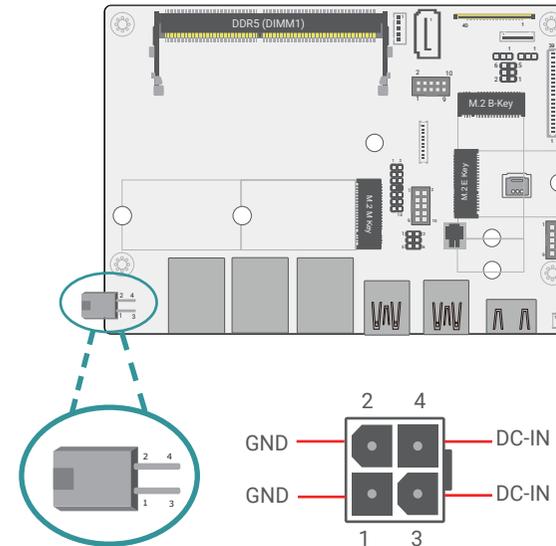
► **Pin Assignment**

System Fan (J10)



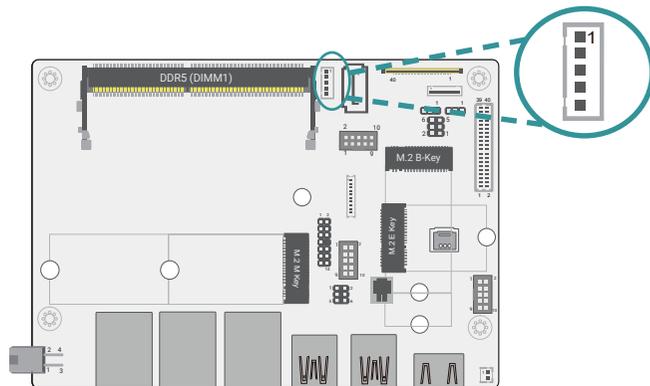
Pin	Assignment
1	TACH
2	VOUT
3	GND

Power Connector (CN11)



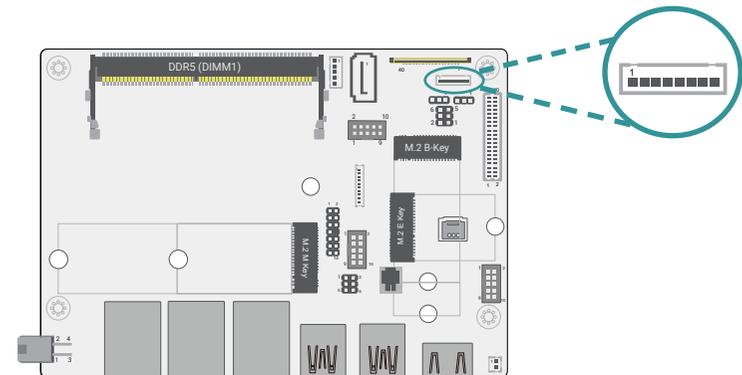
Pin	Assignment
1	GND
2	GND
3	DC-IN
4	DC-IN

SATA Power (J1001)



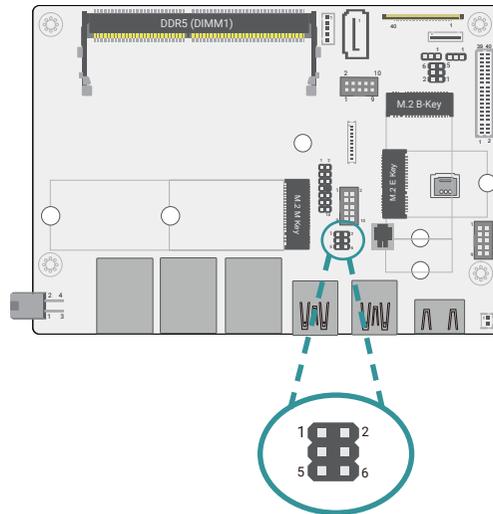
Pin	Assignment
1	5V
2	5V
3	12V
4	GND
5	GND

LVDS Inverter Power (J1002)



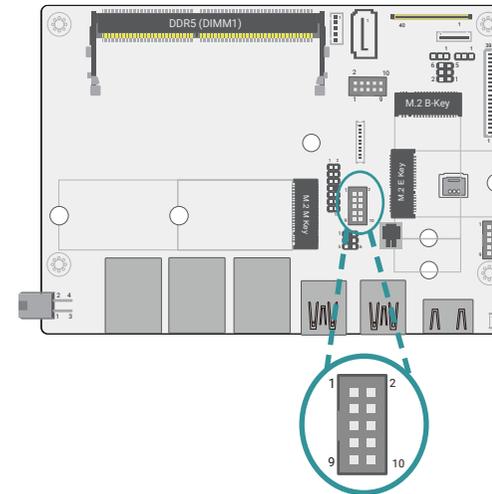
Pin	Assignment
1	GND
2	
3	PWM Brightness Control
4	Panel Power
5	+3.3V
6	Backlight On/Off
7	Inverter Power
8	

Front Panel (J11)



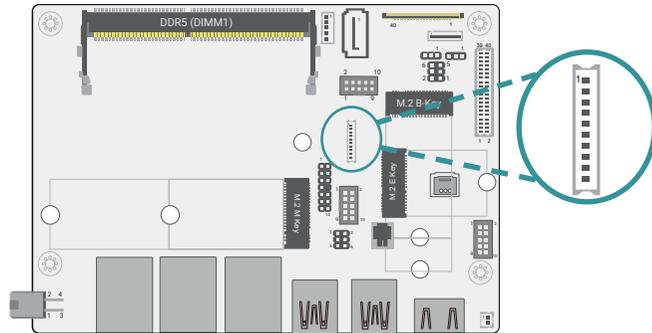
Pin	Assignment	Pin	Assignment
1	Power Button	2	SUS LED Power
3	GND	4	SUS LED
5	Reset	6	HDD LED

COM1 (TSJ1)



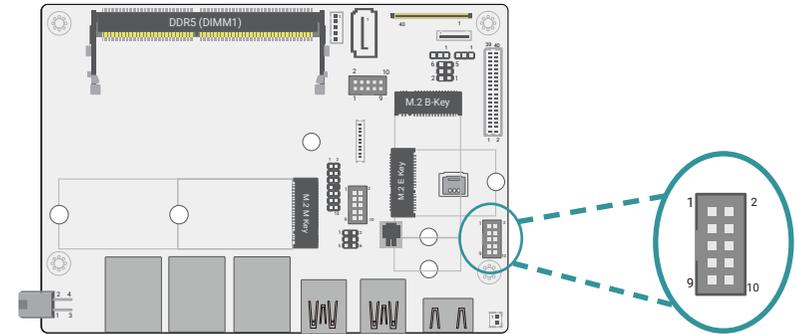
Pin	RS232	RS422	RS485
1	DCD-	TXD-	Data-
2	SIN	TXD+	Data+
3	SOUT	RXD+	NC
4	DTR-	RXD-	NC
5	GND	GND	GND
6	DSR-	NC	NC
7	RTS-	NC	NC
8	CTS-	NC	NC
9	RI-	NC	NC

DIO (J1000)



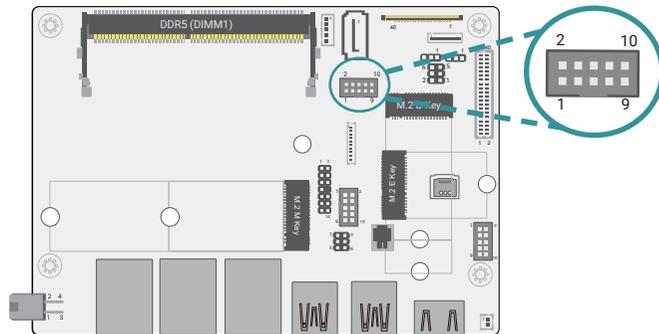
Pin	Assignment
1	DI07
2	DI06
3	DI05
4	DI04
5	DI03
6	DI02
7	DI01
8	DI00
9	5VSB
10	GND

Front Audio (AUJ1)



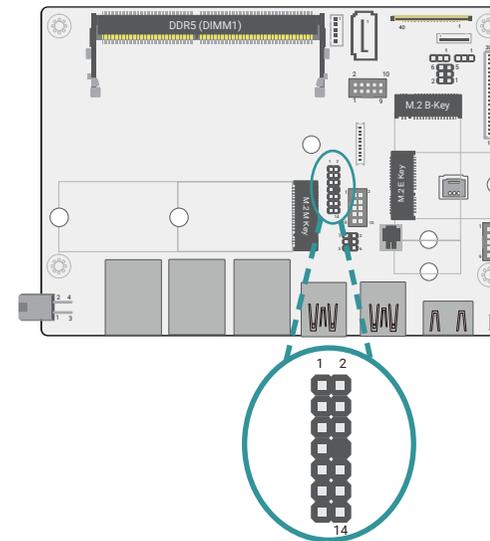
Pin	Assignment	Pin	Assignment
1	Mic-L	2	GND
3	Mic-R	4	NC
5	Line-Out-R	6	Mic-JD
7	GND	8	NC
9	Line-Out-L	10	Line-JD

USB2.0 (J3)



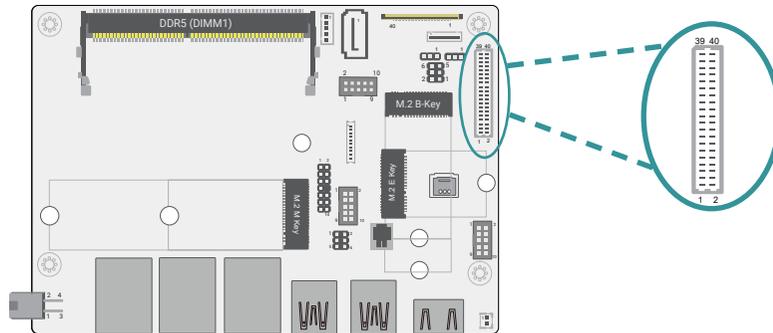
Pin	Assignment	Pin	Assignment
1	VCC	2	VCC
3	-DATA	4	-DATA
5	+DATA	6	+DATA
7	GND	8	GND
9	NC	10	NC

eSPI & UART Debug (J5)



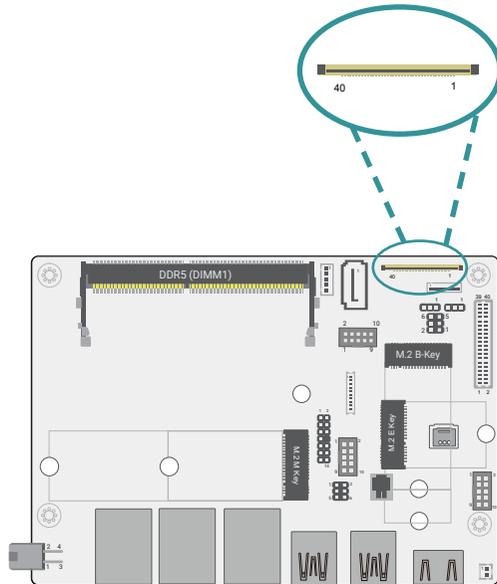
Pin	Assignment	Pin	Assignment
1	3V3SB	2	ESPI_CLK
3	ESPI_RST#	4	GND
5	ESPI_ALT#	6	UART_TX
7	ESPI_D0	8	--
9	ESPI_D1	10	ESPI_CS
11	ESPI_D2	12	UART_RX
13	ESPI_D3	14	3V3SB

LVDS (DPCN1)



Pin	Assignment	Pin	Assignment
1	GND	2	GND
3	LVDSA_Out3+	4	LVDSB_Out3+
5	LVDSA_Out3-	6	LVDSB_Out3-
7	GND	8	GND
9	LVDSA_Out2+	10	LVDSB_Out2+
11	LVDSA_Out2-	12	LVDSB_Out2-
13	GND	14	GND
15	LVDSA_Out1+	16	LVDSB_Out1+
17	LVDSA_Out1-	18	LVDSB_Out1-
19	GND	20	GND
21	LVDSA_Out0+	22	LVDSB_Out0+
23	LVDSA_Out0-	24	LVDSB_Out0-
25	GND	26	GND
27	LVDSA_CLK1+	28	LVDSB_CLK1+
29	LVDSA_CLK1-	30	LVDSB_CLK1-
31	GND	32	GND
33	LVDS_DDC_CLK	34	NC
35	LVDS_DDC_DATA	36	+3.3V
37	Panel Power	38	Panel Power
39	Panel Power	40	Panel Power

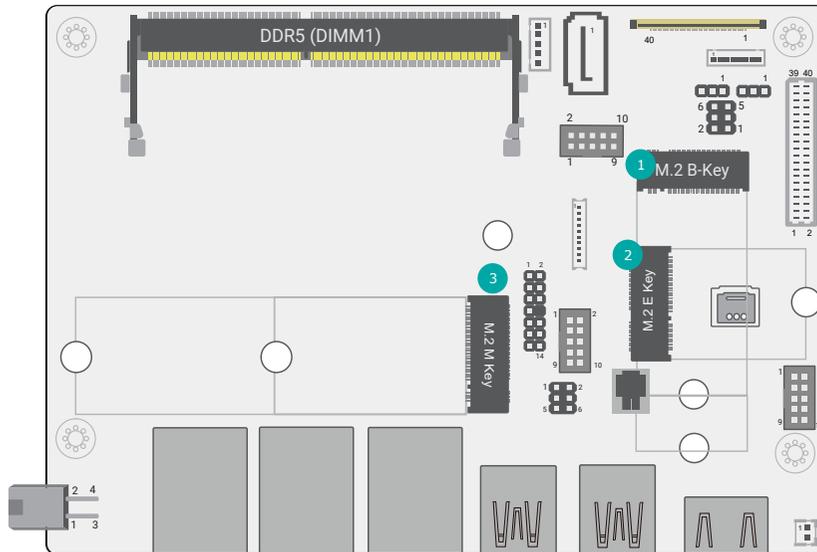
eDP (DPCN2)



Pin	Assignment	Pin	Assignment
1	NC	21	EDP_VCC_PANEL
2	INV_PWR	22	EDP_VCC_PANEL
3	INV_PWR	23	EDP_VCC_PANEL
4	INV_PWR	24	GND
5	INV_PWR	25	eDPB_AUXN
6	NC	26	eDPB_AUXP
7	NC	27	GND
8	DIMMING_1	28	eDPB_LANE0_C_P
9	BLONOFF_1	29	eDPB_LANE0_C_N
10	eDP_GND	30	GND
11	eDP_GND	31	eDPB_LANE1_C_P
12	eDP_GND	32	eDPB_LANE1_C_N
13	eDP_GND	33	GND
14	eDP_HPD_CON_1	34	eDPB_LANE2_C_P
15	GND	35	eDPB_LANE2_C_N
16	GND	36	GND
17	GND	37	eDPB_LANE3_C_P
18	GND	38	eDPB_LANE3_C_N
19	NC	39	GND
20	EDP_VCC_PANEL	40	NC

► Expansion Slots

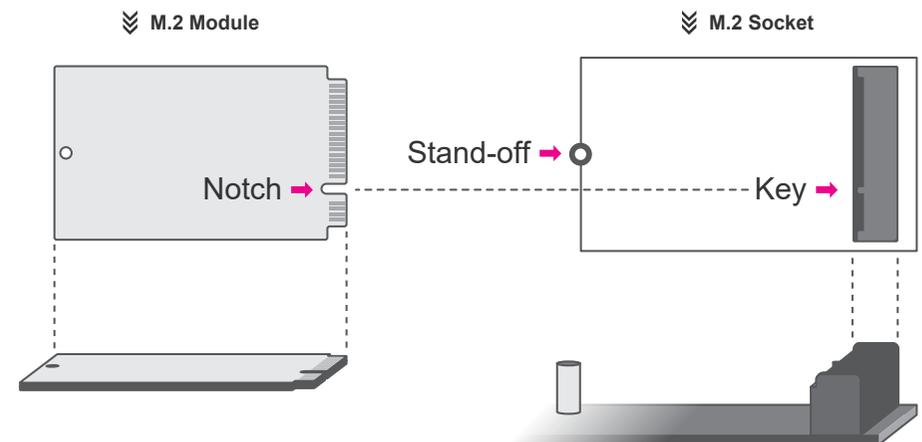
Installing the M.2 Module



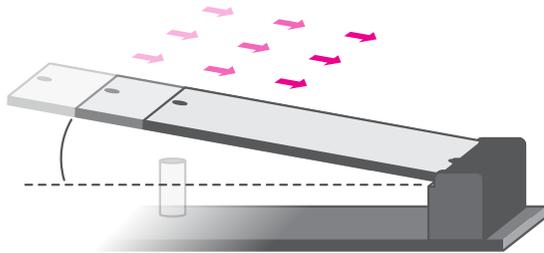
- 1 M.2 B-Key
- 2 M.2 E-Key
- 3 M.2 M-Key

Before installing the M.2 module into the M.2 socket, please make sure that the following safety cautions are well-attended.

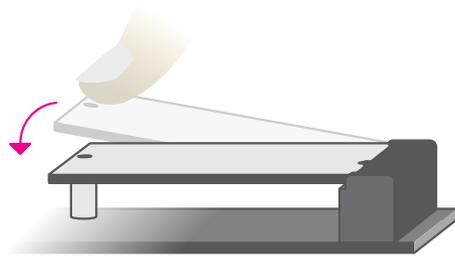
1. Make sure the PC and all other peripheral devices connected to it has been powered down.
2. Disconnect all power cords and cables.
3. Locate the M.2 socket on the system board
4. Make sure the notch on card is aligned to the key on the socket.
5. Make sure the standoff screw is removed from the standoff.



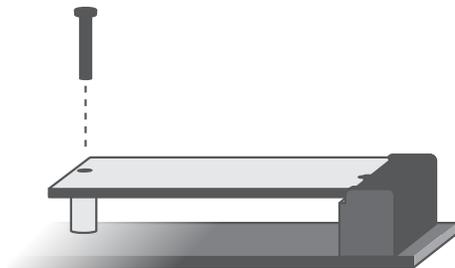
Please follow the steps below to install the card into the socket.



Step 1:
Insert the card into the socket at an angle while making sure the notch and key are perfectly aligned.

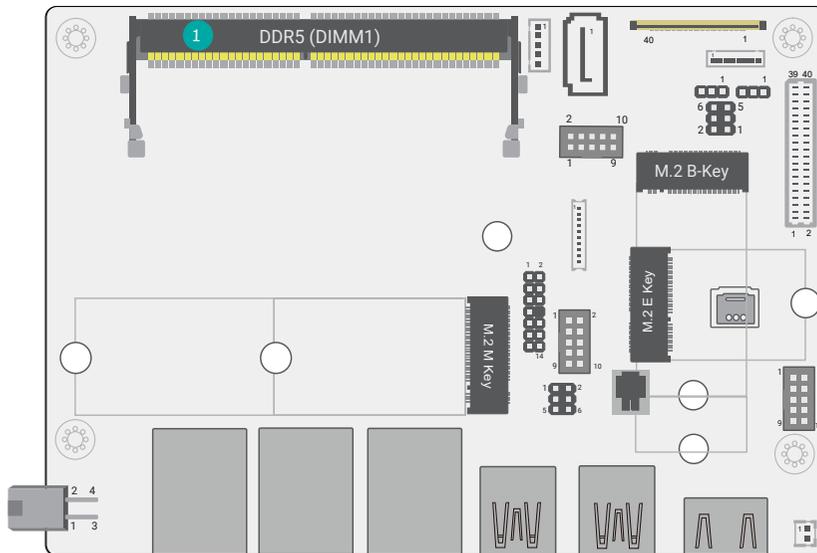


Step 2:
Press the end of the card far from the socket down until against the stand-off.



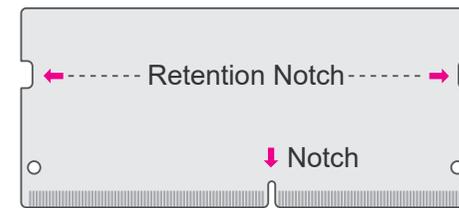
Step 3:
Screw tight the card onto the stand-off with a screw driver and a stand-off screw until the gap between the card and the stand-off closes up. The card should be lying parallel to the board when it's correctly mounted.

Installing the SO-DIMM Module

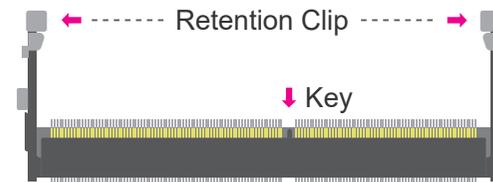


Before installing the memory module, please make sure that the following safety cautions are well-attended.

1. Make sure the PC and all other peripheral devices connected to it has been powered down.
2. Disconnect all power cords and cables.
3. Locate the SO-DIMM socket on the system board
4. Make sure the notch on memory card is aligned to the key on the socket.



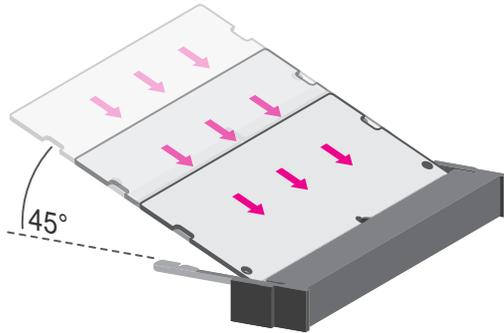
««« **DDR5 SO-DIMM**



««« **Socket Top View**

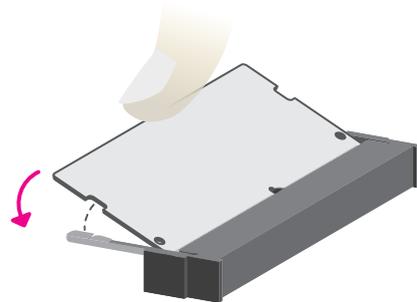
1 DDR5 SO-DIMM

Please follow the steps below to install the memory card into the socket.



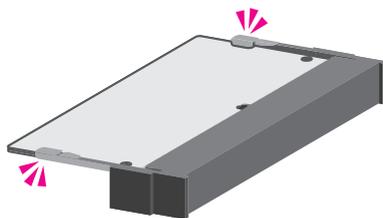
Step 1:

Insert the memory card into the slot while making sure 1) the notch and the key are aligned, and 2) the non-connector end rises approximately 45 degrees horizontally. Press the card firmly into the socket while applying and maintaining even pressure on both ends.



Step 2:

Press the end of the card far from the socket down while making sure the retention notch and the clip align as indicated by the dotted line in the illustration. If the retention notch and the clip do not align, please remove the card and re-insert it. Press the card all the way down.



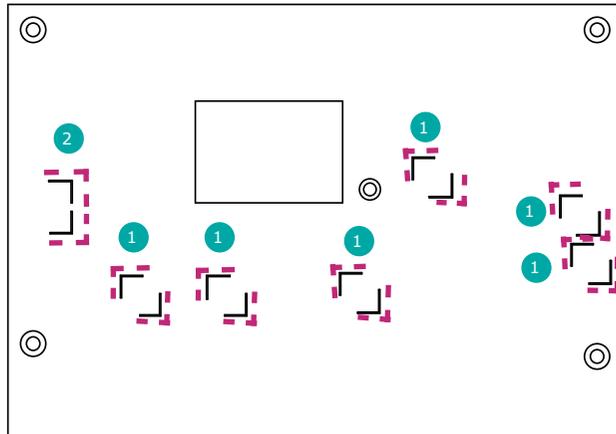
Step 3:

The clips snap automatically and abruptly to the retention notches of the card sounding a distinctive click, and lock the card in place. Inspect that the clip sits in the notch. If not, please pull the clips outward, release and remove the card, and mount it again.

► **Installing the Heatsink**

The locations to paste thermal pads.

On the bottom of the heatsink, you will see the alignment marks to paste seven thermal pads. **Make sure to peel off all the plastic films from every thermal pad before you paste them on the heatsink.**



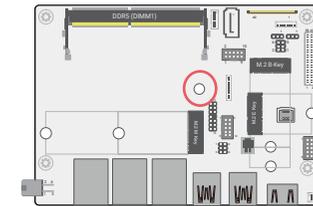
1 PAD_1: GR-25B-0H, 9*9*4

2 PAD_2: XR-HL, 12*15*4

The system board may come with a heatsink, including four stand-offs and four stand-off screws to secure the board and heatsink onto the chassis. The assembly is expected to be installed in the manners as illustrated below.

Step 1:

To avoid damage from the excessive force, please first put the heatsink on the surface and turn the thermal pad side upwards. Remove any plastic film on the interface metal and apply thermal paste/adhesive if it is required. Place the motherboard on top of the heatsink. CPU should be facing the interface metal side of the heat sink.



Make sure the mounting holes are aligned. Screw tight the mounting hole in the middle of the motherboard. Please see the illustration circled in red.

Step 2:

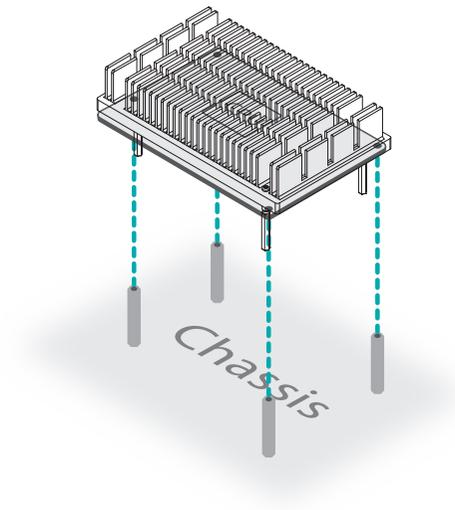
Screw the stand-offs onto the chassis. This step can be omitted if there exist pre-installed stand-offs on the chassis.



Note:
 Do not use excessive force or place direct pressure on the board. It affects the board's performance and may damage the motherboard.

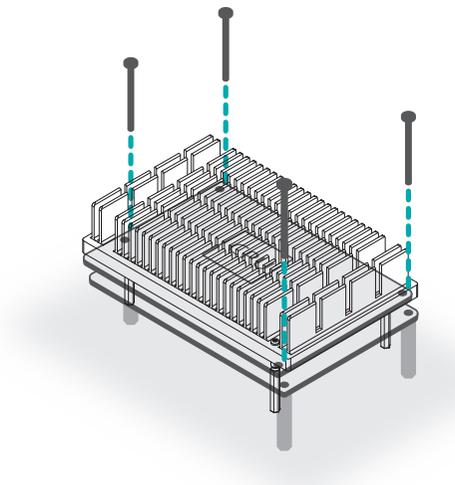
Step 3:

Place the module combo onto the stand-offs. Make sure the stand-off screw holes on the combo and those on the stand-offs align.



Step 4:

Place the stand-off screws provided in the package into the screw holes of the combo. Use a screwdriver to fasten the screws onto the chassis tight.



Note:

It is typical that the chassis is customized, in which case the installation shall vary according to the design of the chassis instead of the instructions provided here.

Chapter 3 - BIOS Settings

► Overview

The BIOS is a program that takes care of the basic level of communication between the CPU and peripherals. It contains codes for various advanced features found in this system board. The BIOS allows you to configure the system and save the configuration in a battery-backed CMOS so that the data retains even when the power is off. In general, the information stored in the CMOS RAM of the EEPROM will stay unchanged unless a configuration change has been made such as a hard drive replaced or a device added.

It is possible that the CMOS battery will fail causing CMOS data loss. If this happens, you need to install a new CMOS battery and reconfigure the BIOS settings.



Note:

The BIOS is constantly updated to improve the performance of the system board; therefore the BIOS screens in this chapter may not appear the same as the actual one. These screens are for reference purpose only.

Default Configuration

Most of the configuration settings are either predefined according to the Load Optimal Defaults settings which are stored in the BIOS or are automatically detected and configured without requiring any actions. There are a few settings that you may need to change depending on your system configuration.

Entering the BIOS Setup Utility

The BIOS Setup Utility can only be operated from the keyboard and all commands are keyboard commands. The commands are available at the right side of each setup screen.

The BIOS Setup Utility does not require an operating system to run. After you power up the system, the BIOS message appears on the screen and the memory count begins. After the memory test, the message "Press DEL to run setup" will appear on the screen. If the message disappears before you respond, restart the system or press the "Reset" button. You may also restart the system by pressing the <Ctrl> <Alt> and keys simultaneously.

Legends

Keys	Function
Right / Left arrow	Move the highlight left or right to select a menu
Up / Down arrow	Move the highlight up or down between submenus or fields
<Enter>	Enter the highlighted submenu
+ (plus key)/F6	Scroll forward through the values or options of the highlighted field
- (minus key)/F5	Scroll backward through the values or options of the highlighted field
<F1>	Display general help
<F2>	Display previous values
<F12>	Popup Boot Device List
<F9>	Optimized defaults
<F10>	Save and Exit
<Esc>	Return to previous menu

Scroll Bar

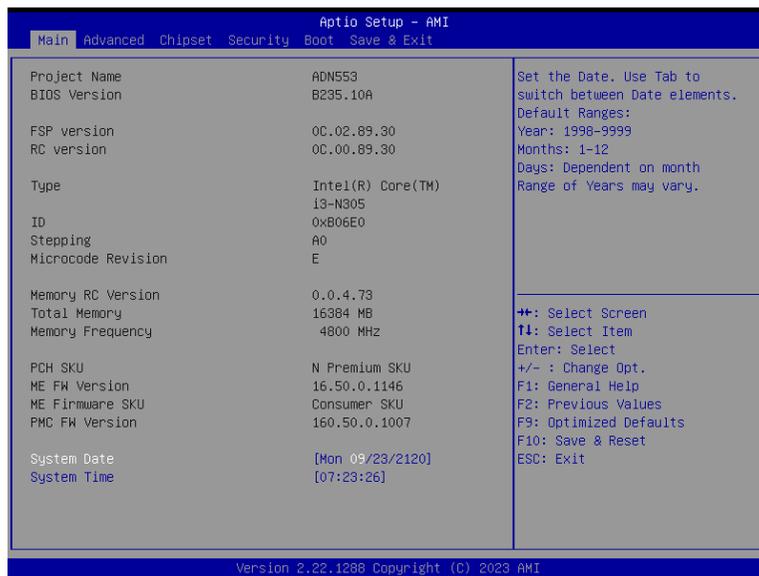
When a scroll bar appears to the right of the setup screen, it indicates that there are more available fields not shown on the screen. Use the <K> and <M> keys to scroll through all the available fields.

Submenu

When "►" appears on the left of a particular field, it indicates that a submenu which contains additional options are available for that field. To display the submenu, move the highlight to that field and press <Enter>.

► Main

The Main menu is the first screen that you will see when you enter the BIOS Setup Utility.



System Date

The date format is <month>, <date>, <year>. Press "Tab" to switch to the next field and press "-" or "+" to modify the value.

System Time

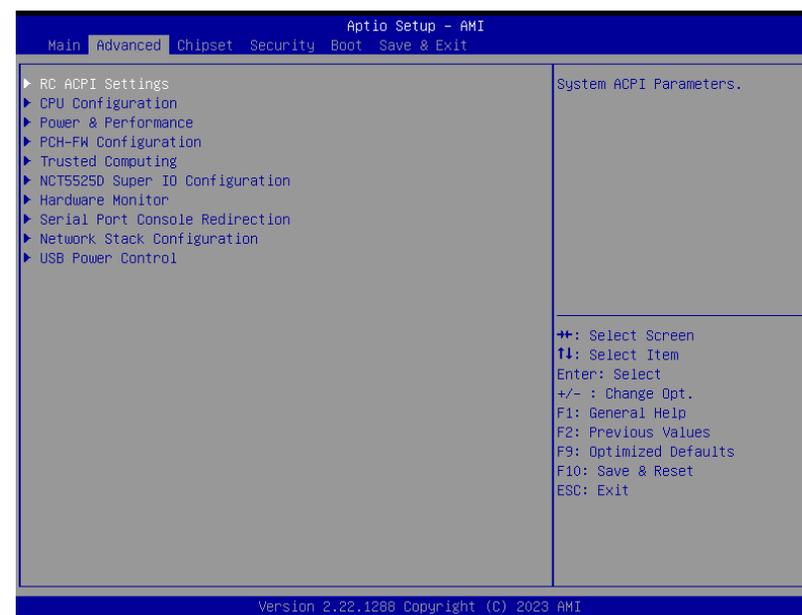
The time format is <hour>, <minute>, <second>. The time is based on the 24-hour military-time clock. For example, 1 p.m. is 13:00:00. Hour displays hours from 00 to 23. Minute displays minutes from 00 to 59. Second displays seconds from 00 to 59.

► Advanced

The Advanced menu allows you to configure your system for basic operation. Some entries are defaults required by the system board, while others, if enabled, will improve the performance of your system or let you set some features according to your preference.



Important:
Setting incorrect field values may cause the system to malfunction.



▶ Advanced

RC ACPI Settings



Wake system from S5 via RTC

When Enabled, the system will automatically power up at a designated time every day. Once it's switched to [Enabled], please set up the time of day – hour, minute, and second – for the system to wake up.

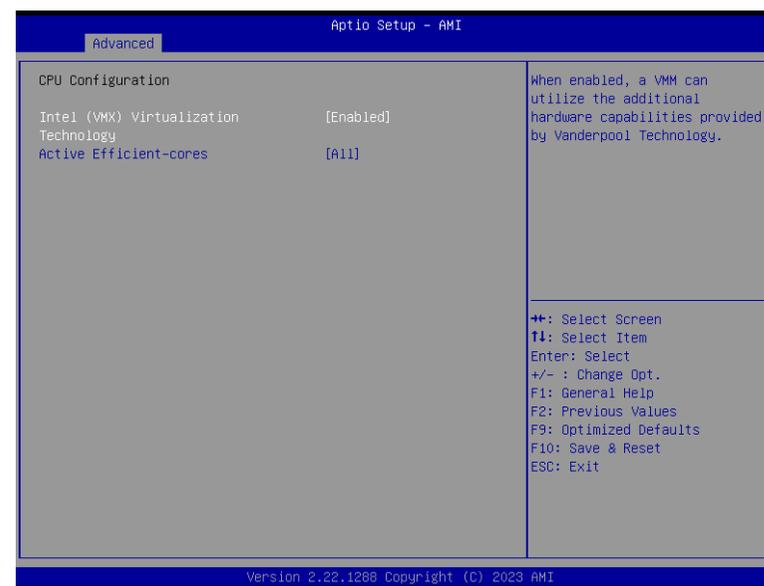
State After G3

Select between S0 State, and S5 State. This field is used to specify what state the system is set to return to when power is re-applied after a power failure (G3 state).

- **S0 State** The system automatically powers on after power failure.
- **S5 State** The system enter soft-off state after power failure. Power-on signal input is required to power up the system.

▶ Advanced

CPU Configuration



Intel (VMX) Virtualization Technology

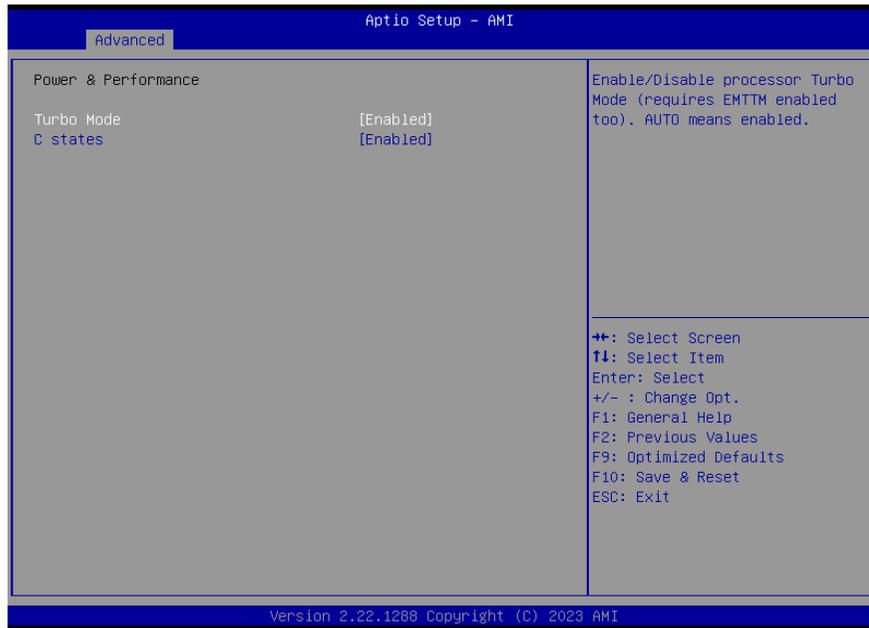
When this field is set to Enabled, the VMM can utilize the additional hardware capabilities provided by Vanderpool Technology.

Active Efficient-cores : [All, 7,6,5,4,3,2,1]

Number of E-cores to enable in each processor package.
 Note: Number of Cores and E-cores are looked at together. When both are {0,0}, the system will enable all cores.

▶ Advanced

Power & Performance



Turbo Mode

Enable or disable turbo mode of the processor. This field will only be displayed when EIST is enabled.

C states

Enable or disable CPU Power Management. It allows CPU to enter "C states" when it's idle and nothing is executing.

▶ Advanced

PCH-FW Configuration

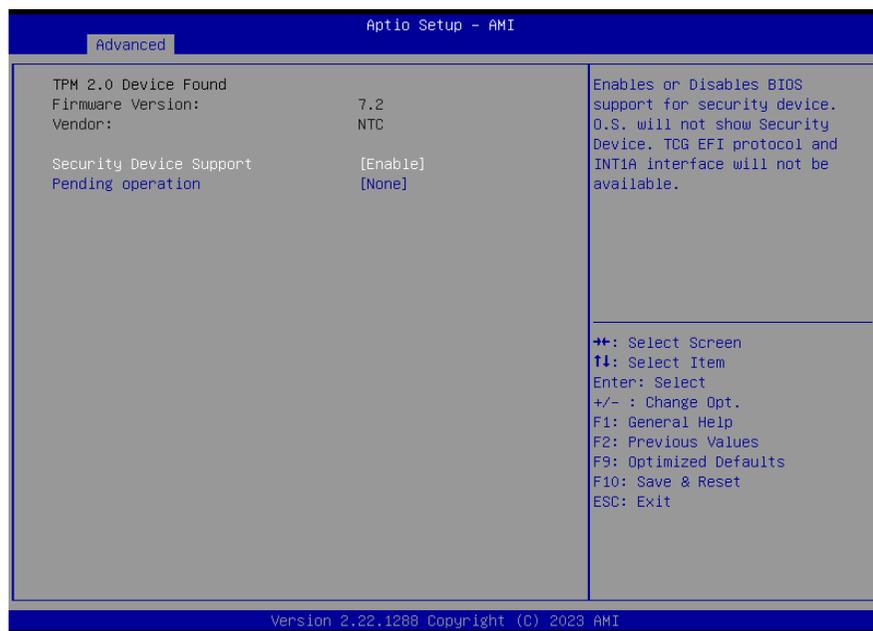


ME FW Image Re-Flash

Enable/Disable Me FW Image Re-Flash function.

▶ Advanced

Trusted Computing



Security Device Support

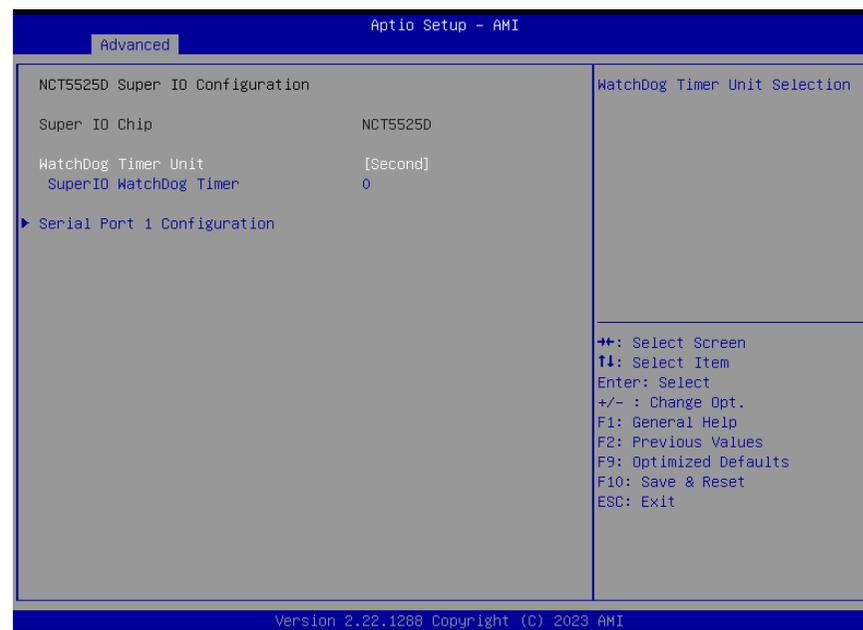
This field is used to enable or disable BIOS support for the security device such as an TPM 2.0 to achieve hardware-level security via cryptographic keys.

Pending operation

To clear the existing TPM encryption, select "TPM Clear" and restart the system. This field is not available when "Security Device Support" is disabled.

▶ Advanced

NCT5525D Super IO Configuration



WatchDog Timer Unit

Select WatchDog Timer Unit – Second or Minute.

SuperIO WatchDog Timer

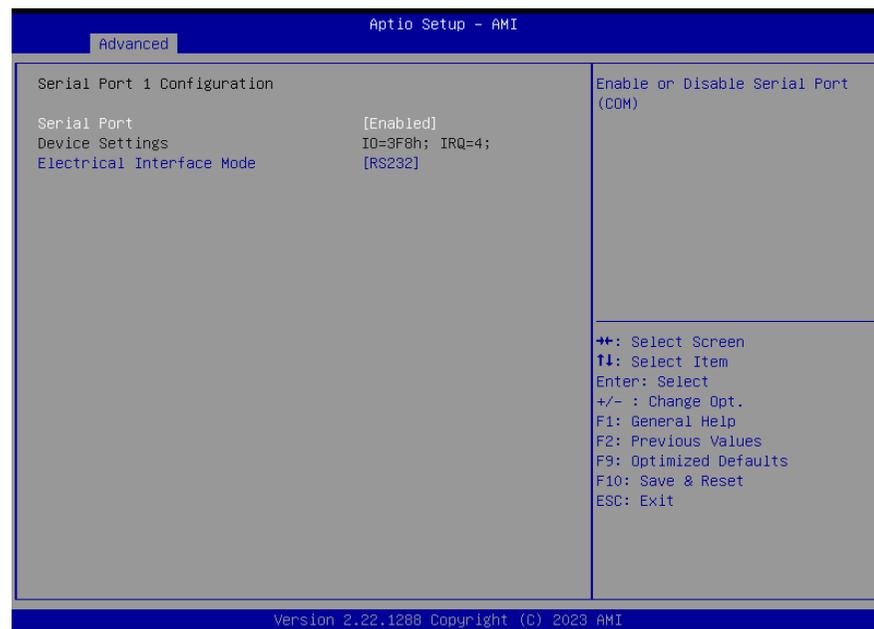
Set SuperIO WatchDog Timer Timeout value. The range is from 0 (disabled) to 255.



Note:
The sub-menus are detailed in following sections.

▶ Advanced

NCT5525D Super IO Configuration ▶ Serial Port 1 Configuration

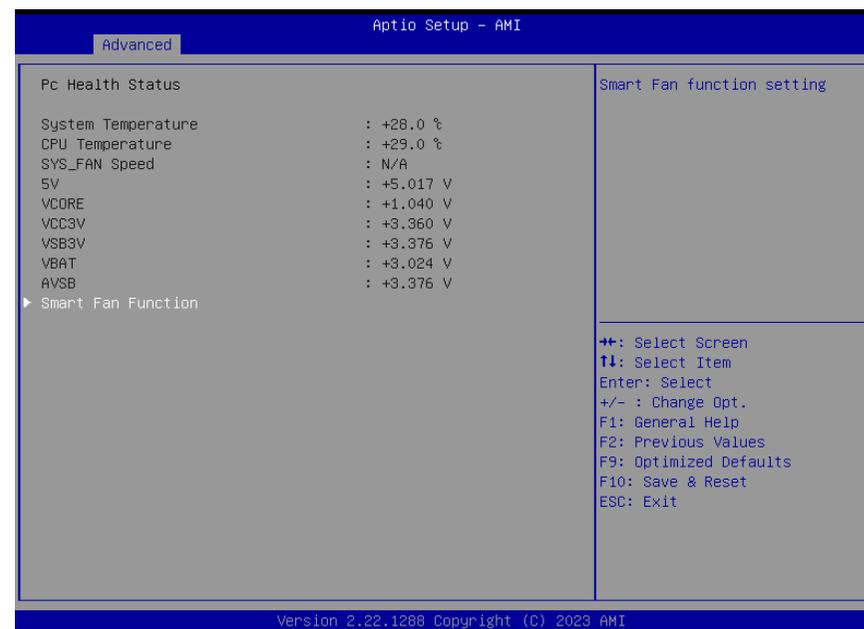


Serial Port

Enable or disable serial port.

▶ Advanced

Hardware Monitor



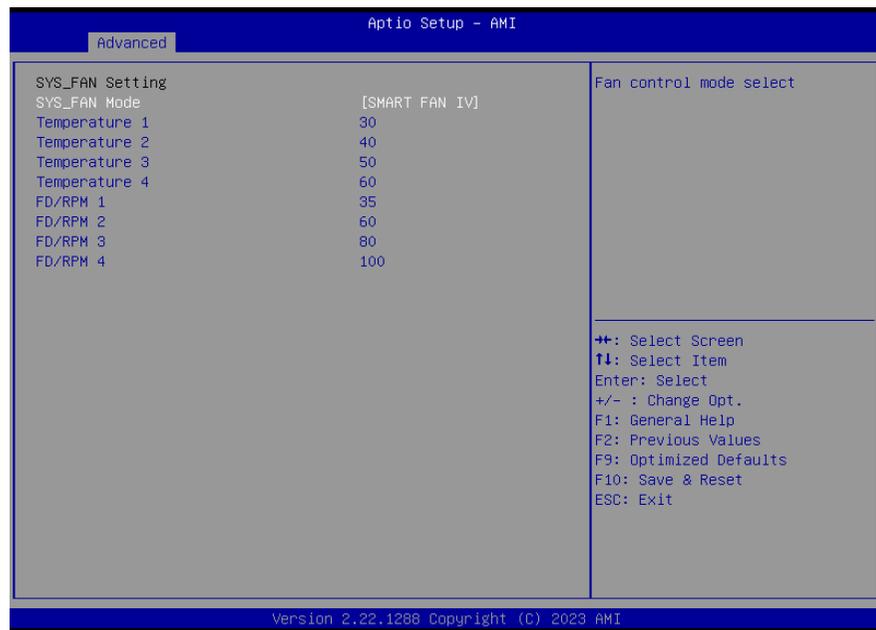
This section displays the system's health information, i.e. voltage readings, CPU and system temperatures, and fan speed readings

Smart Fan Function

Smart Fan Function Setting.

▶ Advanced

Hardware Monitor ▶ Smart Fan Function



SYS_FAN Mode : [Manual Mode, SMART FAN IV]

Fan control mode select.

Temperature 1, 2, 3, 4

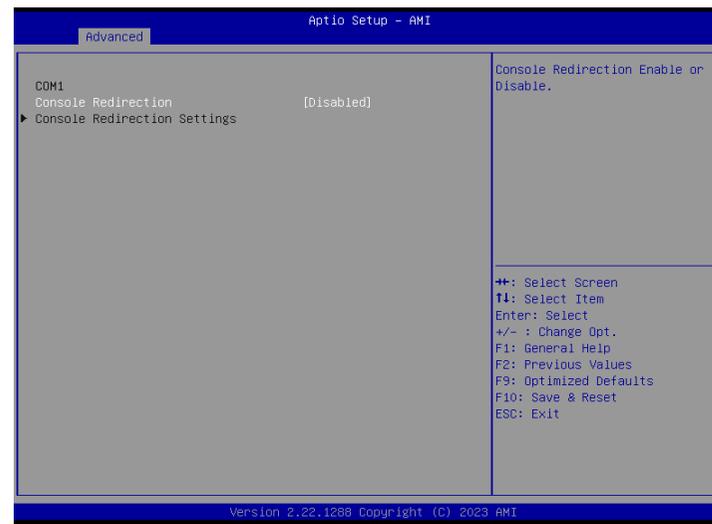
The value of temperature.

FD/RPM 1, 2, 3, 4

The value of Fan Duty/RPM when temperature is T1, T2, T3, T4.

▶ Advanced

Serial Port Console Redirection



► Advanced

Serial Port Console Redirection ► Console Redirection Settings



Configure the serial settings of the current COM port.

Terminal Type

Select terminal type: VT100, VT100+, VT-UTF8 or ANSI.

Bits per second

Select serial port transmission speed: 9600, 19200, 38400, 57600 or 115200.

Data Bits

Select data bits: 7 bits or 8 bits.

Parity

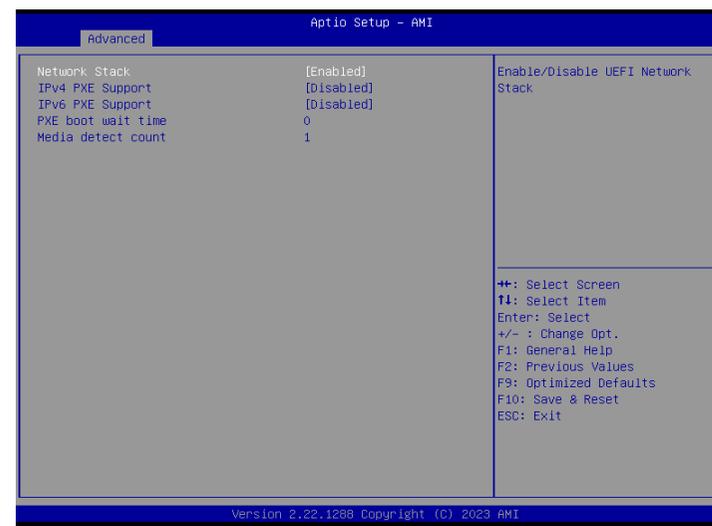
Select parity bits: None, Even, Odd, Mark or Space.

Stop Bits

Select stop bits: 1 bit or 2 bits.

► Advanced

Network Stack Configuration



Network Stack

Enable or disable UEFI network stack. The following fields will appear when this field is enabled.

IPv4 PXE Support

Enable or disable IPv4 PXE boot support. If disabled, IPv4 PXE boot support will not be available.

IPv6 PXE Support

Enable or disable IPv6 PXE boot support. If disabled, IPv6 PXE boot support will not be available.

PXE boot wait time

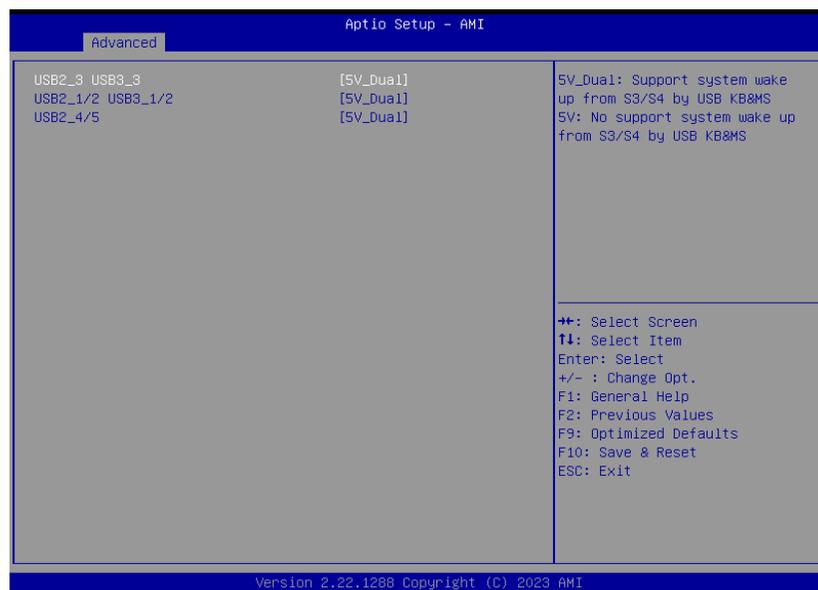
Set the wait time in seconds to press ESC key to abort the PXE boot. Use either +/- or numeric keys to set the value.

Media detect count

Set the number of times the presence of media will be checked. Use either +/- or numeric keys to set the value.

► **Advanced**

USB Power Control



Server CA Configuration

5_Dual: Support system wake up from S3/S4 by USB KB&MS

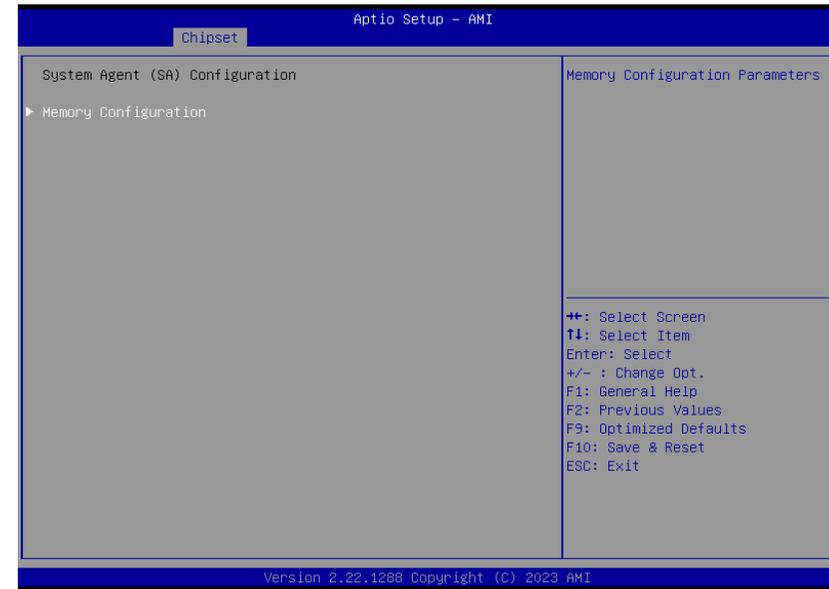
5V: No support system wake up from S3/S4 by USB KB&MS

► Chipset



► Chipset

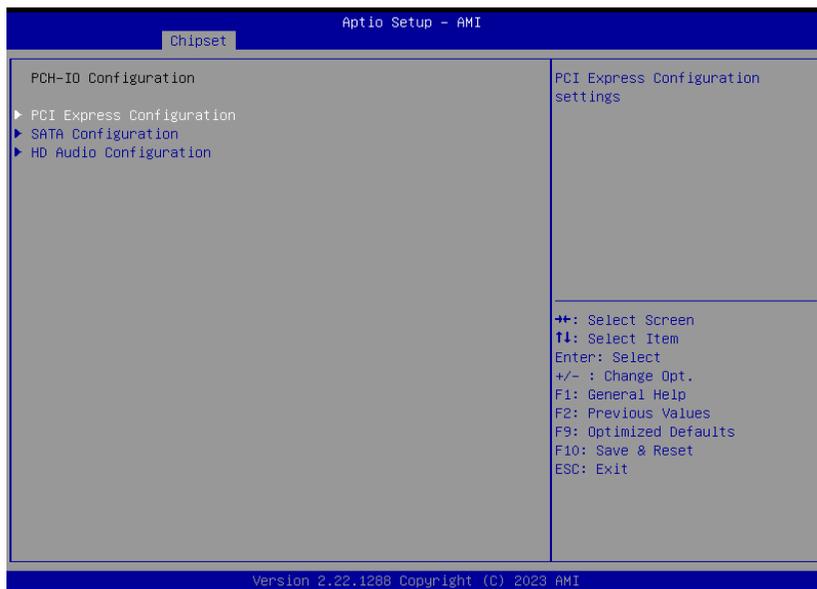
System Agent (SA) Configuration



Please select a submenu and press Enter. The submenus are detailed in the following pages.

► Chipset

PCH-IO Configuration



PCI Express Configuration

PCI Express Configuration Settings

SATA Configuration

SATA Device Options Settings

HD Audio Configuration

HD Audio Subsystem Configuration Settings

► Chipset

PCH-IO Configuration ► PCI Express Configuration



Select one of the PCI Express channels and press enter to configure the following settings.

LAN 1,2,3 M.2-B, M.2-E, M.2-M

Control the PCI Express Root Port.

► Chipset

PCH-IO Configuration ► SATA Configuration



SATA Controller(s)

This field is used to enable or disable the Serial ATA controller.

SATA Mode Selection

The mode selection determines how the SATA controller(s) operates.

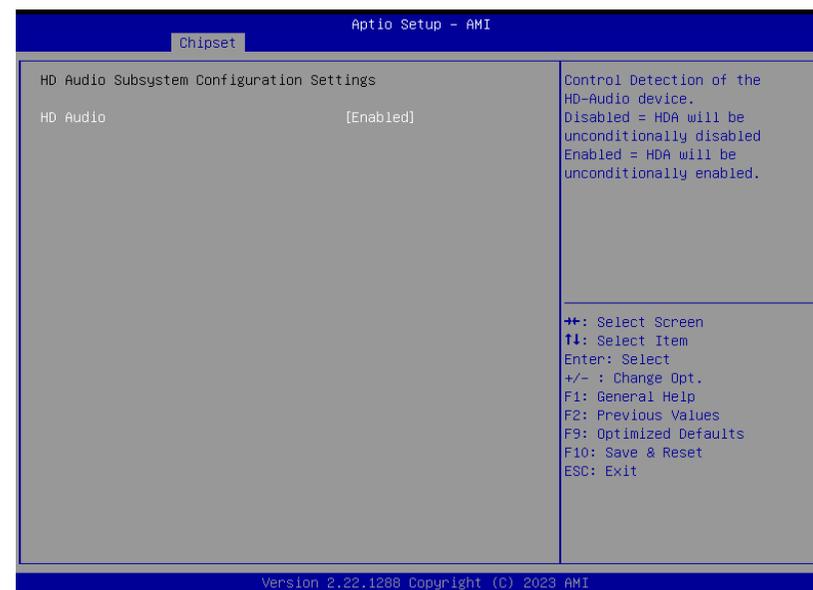
- **AHCI** This option allows the Serial ATA controller(s) to use AHCI (Advanced Host Controller Interface).

Ports

Enable or disable the Serial ATA port.

► Chipset

PCH-IO Configuration ► HD Audio Configuration

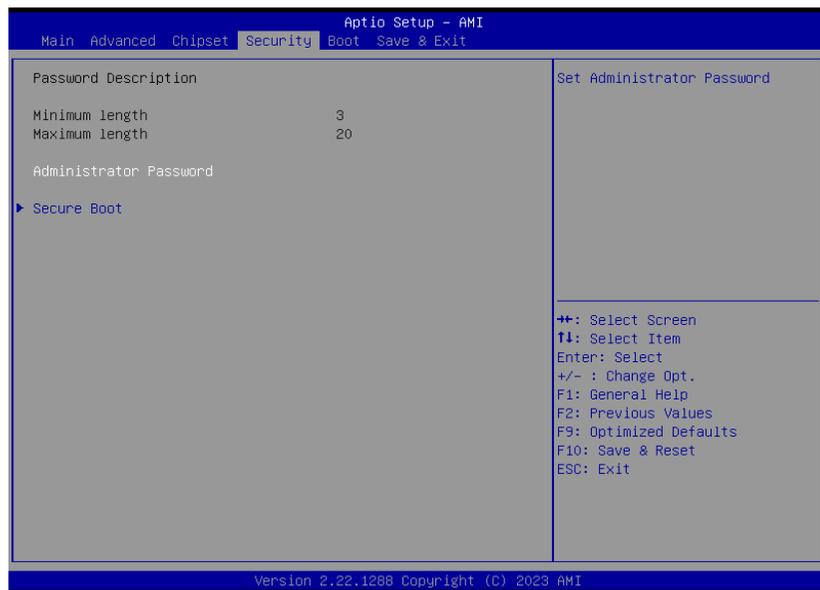


HD Audio

Control the detection of the HD Audio device.

- **Disabled** HDA will be unconditionally disabled.
- **Enabled** HDA will be unconditionally enabled.

► Security

**Administrator Password**

Set the administrator password. To clear the password, input nothing and press enter when a new password is asked. Administrator Password will be required when entering the BIOS.

► Security

Secure Boot

**Secure Boot**

The Secure Boot store a database of certificates in the firmware and only allows the OSe with authorized signatures to boot on the system. To activate Secure Boot, please make sure that "Secure Boot" is "[Enabled]", Platform Key (PK) is enrolled, "System Mode" is "User", and CSM is disabled. After enabling/disabling Secure Boot, please save the configuration and restart the system. When configured and activated correctly, the Secure Boot status will be "Active".

Secure Boot Mode

Select the secure boot mode – Standard or Custom. When set to Custom, the following fields will be configurable for the user to manually modify the key database.

Restore Factory Keys

Force system to User Mode. Load OEM-defined factory defaults of keys and databases onto the Secure Boot. Press Enter and a prompt will show up for you to confirm.

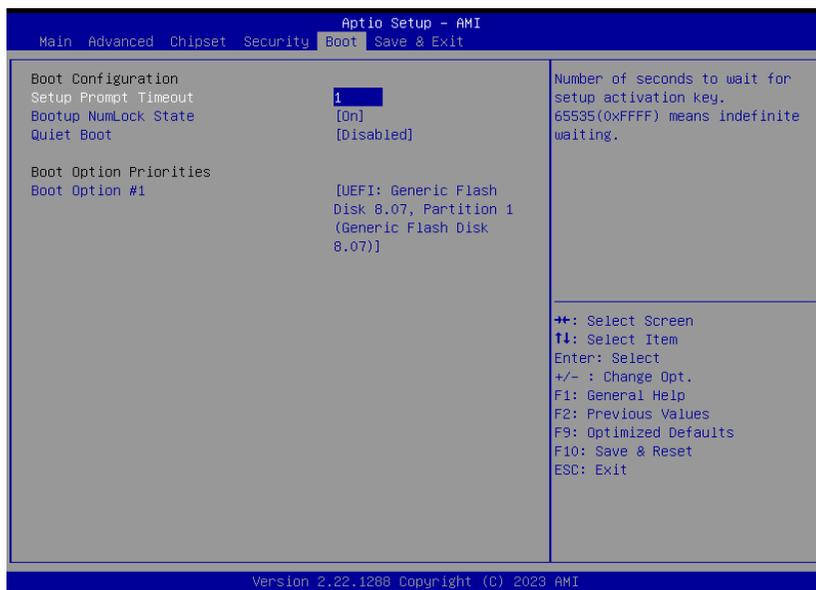
Reset To Setup Mode

Clear the database from the NVRAM, including all the keys and signatures installed in the Key Management menu. Press Enter and a prompt will show up for you to confirm.

Key Management

Enables expert users to modify Secure Boot Policy variables without full authentication.

► Boot

**Setup Prompt Timeout**

Set the number of seconds to wait for the setup activation key. 65535 (0xFFFF) denotes indefinite waiting.

Bootup NumLock State

Select the keyboard NumLock state: On or Off.

Quiet Boot

This section is used to enable or disable quiet boot option.

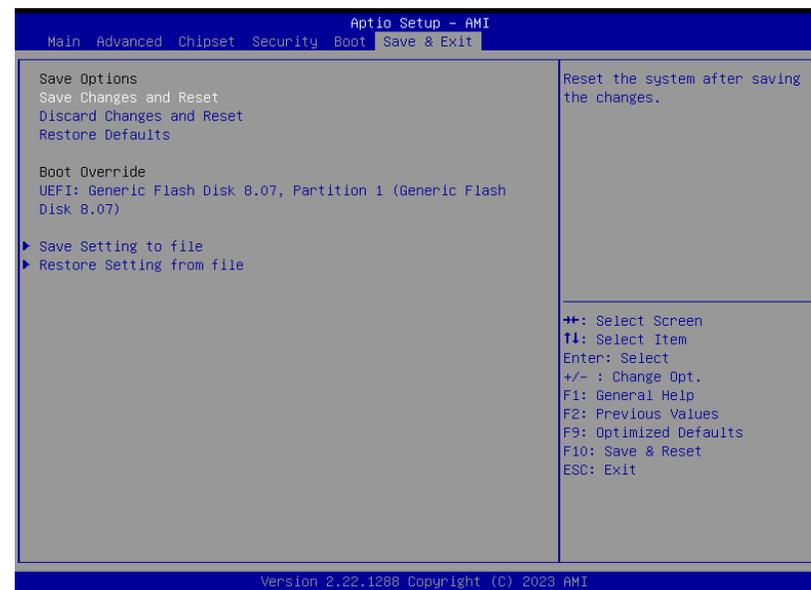
Boot Option Priorities

Rearrange the system boot order of available boot devices.

**Note:**

If "Quiet Boot" is enabled, "BGRT Logo" will show up for configuration.

► Save & Exit

**Save Changes and Reset**

To save the changes, select this field and then press <Enter>. A dialog box will appear. Select Yes to reset the system after saving all changes made.

Discard Changes and Reset

To discard the changes, select this field and then press <Enter>. A dialog box will appear. Select Yes to reset the system setup without saving any changes.

Restore Defaults

To restore and load the optimized default values, select this field and then press <Enter>. A dialog box will appear. Select Yes to restore the default values of all the setup options.

Boot Override

Move the cursor to an available boot device and press Enter, and then the system will immediately boot from the selected boot device. The Boot Override function will only be effective for the current boot. The "Boot Option Priorities" configured in the Boot menu will not be changed.

- **Save Setting to file** Select this option to save BIOS configuration settings to a USB flash device.
- **Restore Setting from file** This field will appear only when a USB flash device is detected. Select this field to restore setting from the USB flash device.

► Updating the BIOS

To update the BIOS, you will need the new BIOS file and a flash utility. Please contact technical support or your sales representative for the files and specific instructions about how to update BIOS with the flash utility.

► Notice: BIOS SPI ROM

1. The Intel® Management Engine has already been integrated into this system board. Due to the safety concerns, the BIOS (SPI ROM) chip cannot be removed from this system board and used on another system board of the same model.
2. The BIOS (SPI ROM) on this system board must be the original equipment from the factory and cannot be used to replace one which has been utilized on other system boards.
3. If you do not follow the methods above, the Intel® Management Engine will not be updated and will cease to be effective.



Note:

- a. You can take advantage of flash tools to update the default configuration of the BIOS (SPI ROM) to the latest version anytime.
- b. When the BIOS IC needs to be replaced, you have to populate it properly onto the system board after the EEPROM programmer has been burned and follow the technical person's instructions to confirm that the MAC address should be burned or not.

Appendix A- Mating Connectors

► The Mating Connectors List

Please refer to the following list of the mating connectors.

Function	Connector	Connector information	Rate output
System Fan	J10	E-CALL, 0110-3221030: 1*3, 1.25mm, WAFER	12V/0.5A
Front Audio	AUJ1	PINREX, 52C-90-10GBE0: 2*5, 2.0mm, BOX HEADER	NA
Front Panel	J11	PINREX, 52C-90-06GBE0: 2*3, 2.0mm, BOX HEADER	NA
COM1	TSJ1	PINREX, 52C-90-10GBE0: 2*5, 2.0mm, BOX HEADER	NA
eSPI & UART Debug	J5	PINREX, 222-97-07GBEK: 2*7P-1(K8), 2.0mm, PIN PLUG	NA
DIO	J1000	JST, BM10B-SRSS-TB1(LF)(SN): 1*10P, 1.0mm, BOX HEADER	5VSB/0.5A
LVDS	DPCN1	PINREX, 712-76-40GWE0: 40P, 1.25mm, WTB HEADER	3.3V(Default)/5V/12V, 1.5A
LVDS Inverter Power	J1002	MOLEX, 53398-0871: 1*8P, 1.25mm, BOX HEADER	12V(Default)/5V, 1.5A
USB2.0	J3	PINREX, 52C-90-10GBE0: 2*5, 2.0mm, BOX HEADER	5V/1A
eDP	DPCN2	STM, MSAK24025P40C: 1*40P, 0.5mm, eDP CONN	eDP Panel Power: 3.3V(Default)/5V/12V, 1.5A eDP Inverter Power: 12V(Default)/5V, 1.5A
SATA Power	J1001	MOLEX, 53398-0571: 5P, 1.25mm, Wafer	5V/12V, 1.5A